



Infineon Technologies Key Facts Regensburg

Established:	1959
Total area:	237,000 m ²
Employees:	approx. 2.800

Regensburg site covers the entire production cycle for semiconductor solutions:

Chip production: ICs for automotive and industrial (e.g. in airbags, ABS, motor management)
for security applications (e.g. banking, health care)
for wireless and wireline communications (e.g. in mobile phones, broadband solutions)

Chip card modules assembly: development and volume production of modules for chip card applications in Regensburg-Burgweinting
Lead fab for technology, innovation and marketing

Corporate Assembly and Test: lead fab for multi-chip modules and sensors

Worldwide competence center for assembly processes and interconnect technology